

General Description

The WSD3066DN is the highest performance trench N-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSD3066DN meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

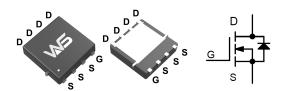
Product Summery

BVDSS	RDSON	ID
30V	4.7mΩ	66A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

DFN3X3-8 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage 30		V
V_{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	66	Α
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹	40	А
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	15	А
I _D @T _A =70℃	Continuous Drain Current, V _{GS} @ 10V ¹ 10		Α
I _{DM} @Тс=25°С	Pulsed Drain Current ² 150		Α
EAS	Avalanche Energy ,Single Pulse (L=0.1mH) ³ 125		mJ
I _{AS}	Avalanche Current ,Single pulse(L=0.1mH) ³	50	Α
P _D @T _C =25°C	Total Power Dissipation⁴	45	W
P _D @T _A =25℃	Total Power Dissipation ⁴ 1.78		W
T _{STG}	Storage Temperature Range	-55 to 150	$^{\circ}$
TJ	Operating Junction Temperature Range	-55 to 150	${\mathbb C}$

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-Ambient ¹		70	°C/W
R _{0JC}	Thermal Resistance Junction-Case ¹		2.7	°C/W



Electrical Characteristics (T_J=25 ℃, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25℃ , I _D =1mA		0.028		V/°C
В	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =40A		4.7	5.7	0
R _{DS(ON)}		V _{GS} =4.5V , I _D =20A		5.8	7.6	mΩ
V _{GS(th)}	Gate Threshold Voltage	\\ _\\ 2504	1.5	1.8	2.5	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250uA$		-6.06		mV/℃
	Dunin Course Lookers Course	V _{DS} =24V , V _{GS} =0V , T _J =25℃			1	· uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =55℃			30	
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm 20 V$, V_{DS} = $0 V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =20A		44		S
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.0	1.1	Ω
Qg	Total Gate Charge (4.5V)	V _{DS} =15V , V _{GS} =4.5V , I _D =20A		27.5	38.5	
Q_gs	Gate-Source Charge			9.6	13.4	nC
Q _{gd}	Gate-Drain Charge			9.4	13.7	
T _{d(on)}	Turn-On Delay Time			18.5	34	
Tr	Rise Time	V _{DD} =15V , V _{Gen} =10V ,		11.3	21	
T _{d(off)}	Turn-Off Delay Time	$R_G=6\Omega$, $I_D=1A$, $R_L=15\Omega$.		62.5	114	- ns
T _f	Fall Time			23.5	43	
C _{iss}	Input Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		1320	1420	
C _{oss}	Output Capacitance			610	640	pF
C _{rss}	Reverse Transfer Capacitance			112	150	

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy ⁵	V _{DD} =25V , L=0.5mH , I _{AS} =20A		125		mJ

Diode Characteristics

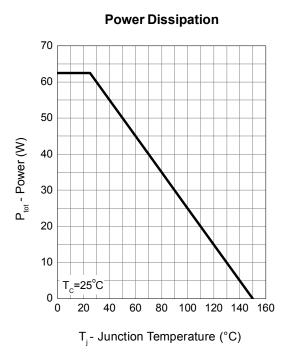
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6})/ -\/ -0\/ Fores Current			15	Α
I _{SM}	Pulsed Source Current ^{2,6}	V _G =V _D =0V , Force Current			45	Α
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25℃			1	V
t _{rr}	Reverse Recovery Time			23		nS
Qrr	Reverse Recovery Charge	IF=40A,dI/dt=100A/µs,TJ=25℃		7		nC

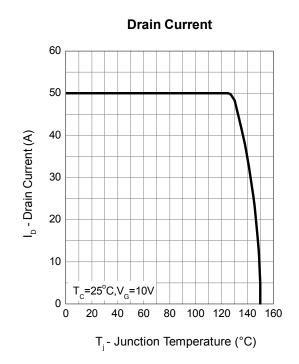
Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, t<10sec.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.5mH, I_{AS} =20A
- 5.The Min. value is 100% EAS tested guarantee.
- $6. The \ data \ is \ theoretically \ the \ same \ as \ I_D \ and \ I_{DM} \ , in \ real \ applications \ , should \ be \ limited \ by \ total \ power \ dissipation.$

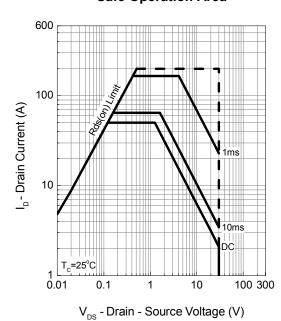


Typical Characteristics

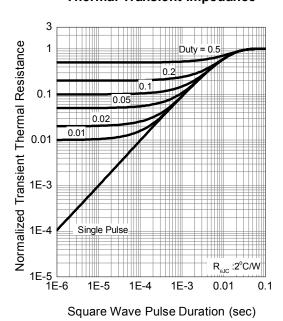




Safe Operation Area

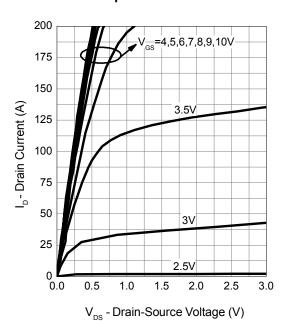


Thermal Transient Impedance

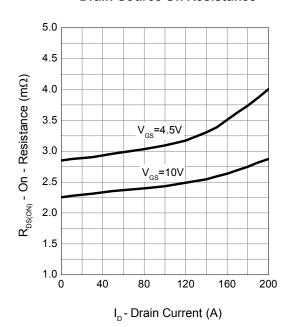




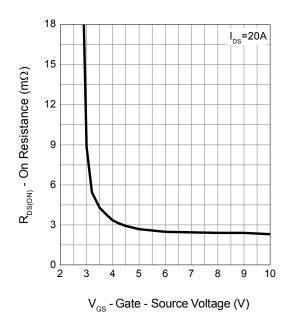
Output Characteristics



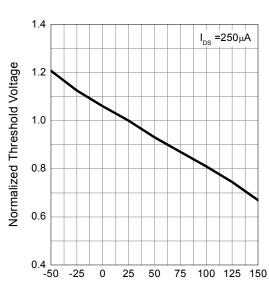
Drain-Source On Resistance



Gate-Source On Resistance



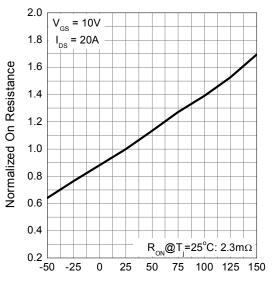
Gate Threshold Voltage



T_i - Junction Temperature (°C)

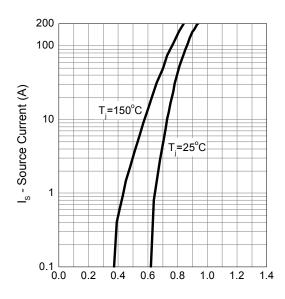


Drain-Source On Resistance



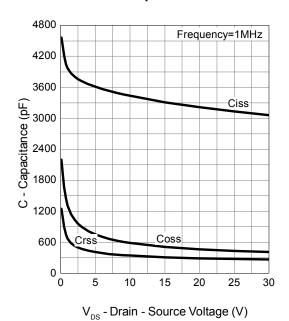
T_i - Junction Temperature (°C)

Source-Drain Diode Forward

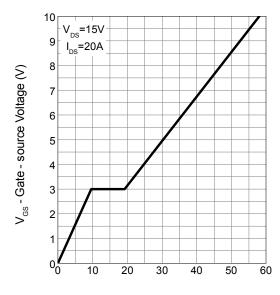


V_{SD} - Source - Drain Voltage (V)

Capacitance



Gate Charge



Q_G - Gate Charge (nC)



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